

V_{DSM} = 2800 V
 I_{TAVM} = 5080 A
 I_{TRMS} = 7970 A
 I_{TSM} = 75000 A
 V_{TO} = 0.86 V
 r_T = 0.07 mΩ

Phase Control Thyristor

5STP 45N2800

Doc. No. 5SYA1007-03 Jan. 02

- Patented free-floating silicon technology
- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability
- Interdigitated amplifying gate

Blocking

Maximum rated values ¹⁾

Symbol	Conditions	5STP 45N2800	5STP 45N2600	5STP 45N2200
V_{DRM}, V_{RRM}	$f = 50 \text{ Hz}, t_p = 10\text{ms}$	2800 V	2600 V	2200 V
V_{RSM1}	$t_p = 5\text{ms, single pulse}$	3000 V	2800 V	2400 V
dV/dt_{crit}	Exp. to $0.67 \times V_{DRM}, T_j = 125^\circ\text{C}$		1000 V/ μs	

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Forward leakage current	I_{DRM}	$V_{DRM}, T_j = 125^\circ\text{C}$			400	mA
Reverse leakage current	I_{RRM}	$V_{RRM}, T_j = 125^\circ\text{C}$			400	mA

Mechanical data

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_M		81	90	108	kN
Acceleration	a	Device unclamped			50	m/s^2
Acceleration	a	Device clamped			100	m/s^2

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m			2.9		kg
Surface creepage distance	D_S		56			mm
Air strike distance	D_a		22			mm

¹⁾ Maximum Ratings are those values beyond which damage to the device may occur

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On-state*Maximum rated values¹⁾*

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	I _{TAVM}	Half sine wave, T _c = 70°C			5080	A
RMS on-state current	I _{TRMS}				7970	A
Max. peak non-repetitive surge current	I _{TSM}	tp = 10 ms, T _j = 125°C, V _D =V _R = 0 V			75000	A
Limiting load integral	I ² t				28125	kA ² s
Max. peak non-repetitive surge current	I _{TSM}	tp = 8.3 ms, T _j = 125°C, V _D =V _R =0 V			79000	A
Limiting load integral	I ² t				25900	kA ² s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V _T	I _T = 6000 A, T _j = 125°C			1.29	V
Threshold voltage	V _{T0}	I _T = 3000 A - 9000 A, T _j = 125°C			0.86	V
Slope resistance	r _T	T _j = 125°C			0.07	mΩ
Holding current	I _H	T _j = 25°C			100	mA
		T _j = 125°C			75	mA
Latching current	I _L	T _j = 25°C			500	mA
		T _j = 125°C			350	mA

Switching*Maximum rated values¹⁾*

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di/dt _{crit}	T _j = 125°C, I _{TRM} = 3000 A, V _D ≤ 0.67·V _{DRM} , I _{FG} = 2 A, t _r = 0.5 μs	Cont. f = 50 Hz		250	A/μs
Critical rate of rise of on-state current	di/dt _{crit}		Cont. f = 1Hz		1000	A/μs
Circuit-commutated turn-off time	t _q	T _j = 125°C, I _{TRM} = 3000 A, V _R = 200 V, di _T /dt = -5 A/μs, V _D ≤ 0.67·V _{DRM} , dv _D /dt = 20 V/μs,	400			μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Recovery charge	Q _{rr}	T _j = 125°C, I _{TRM} = 3000 A, V _R = 200 V, di _T /dt = -5 A/μs	4200		6500	μAs
Delay time	t _d	V _D = 0.4·V _{DRM} , I _{FG} = 2 A, t _r = 0.5 μs			3	μs

Triggering

Maximum rated values¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward gate voltage	V _{FGM}				12	V
Peak forward gate current	I _{FGM}				10	A
Peak reverse gate voltage	V _{RGM}				10	V
Gate power loss	P _G	For DC gate current			3	W
Average gate power loss	P _{GAV}		see Fig. 9			

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate trigger voltage	V _{GT}	T _j = 25°C			2.6	V
Gate trigger current	I _{GT}	T _j = 25°C			400	mA
Gate non-trigger voltage	V _{GD}	V _D = 0.4 x V _{DRM} , T _{vjmax} = 125°C	0.3			V
Gate non-trigger current	I _{GD}	V _D = 0.4 x V _{DRM} , T _{vjmax} = 125°C	10			mA

Thermal

Maximum rated values¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T _j				125	°C
Storage temperature range	T _{stg}		-40		140	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	R _{th(j-c)}	Double side cooled			5.7	K/kW
	R _{th(j-c)A}	Anode side cooled			11.4	K/kW
	R _{th(j-c)C}	Cathode side cooled			11.4	K/kW
Thermal resistance case to heatsink	R _{th(c-h)}	Double side cooled			1	K/kW
	R _{th(c-h)}	Single side cooled			2	K/kW

Analytical function for transient thermal impedance:

$$Z_{thJC}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
R _i (K/kW)	3.4	1.26	0.68	0.35
τ _i (s)	0.8685	0.1572	0.0219	0.0078

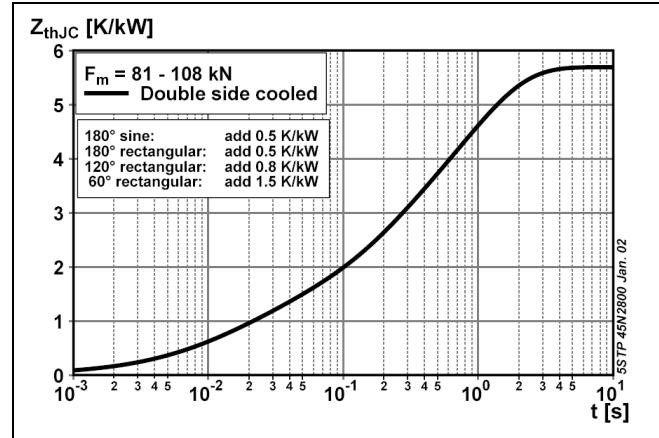


Fig. 1 Transient thermal impedance junction-to case.

On-state characteristic model:

$$VT = A + B \cdot iT + C \cdot \ln(iT + 1) + D \cdot \sqrt{iT}$$

Valid for $i_T = 500 - 15000$ A

A	B	C	D
-9.6289e-2	5.1000e-5	1.3573e-1	-1.3580e-3

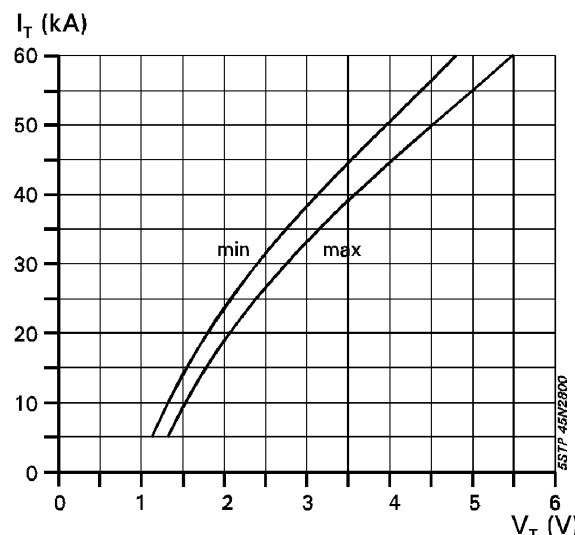


Fig. 2 On-state characteristics.
 $T_j=125^\circ\text{C}$, 10ms half sine

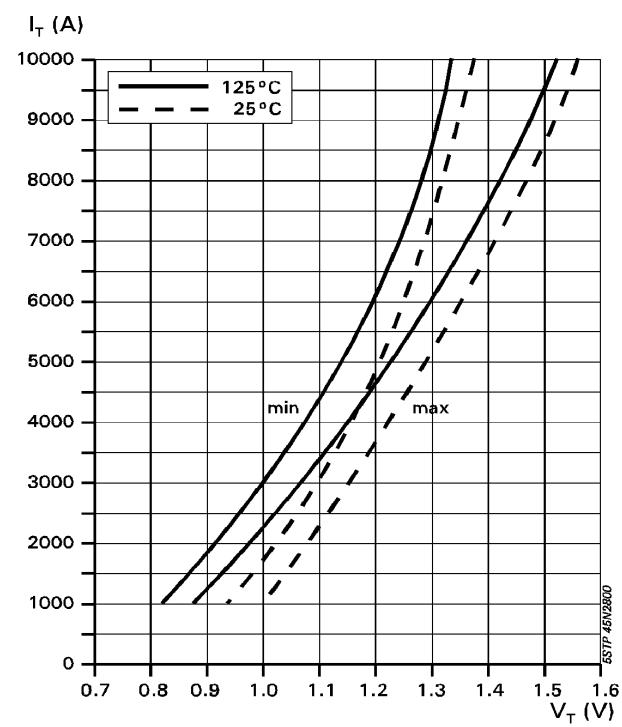


Fig. 3 On-state characteristics.

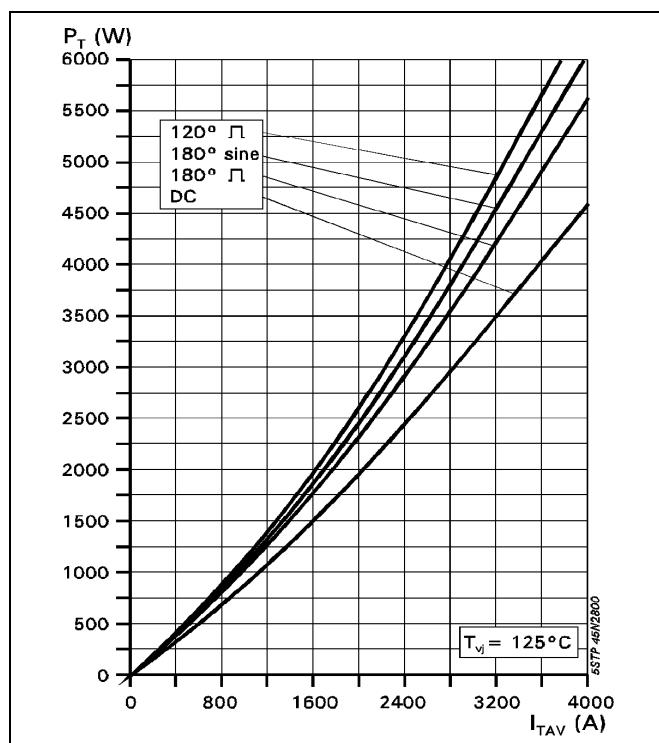


Fig. 4 On-state power dissipation vs. mean on-state current. Turn - on losses excluded.

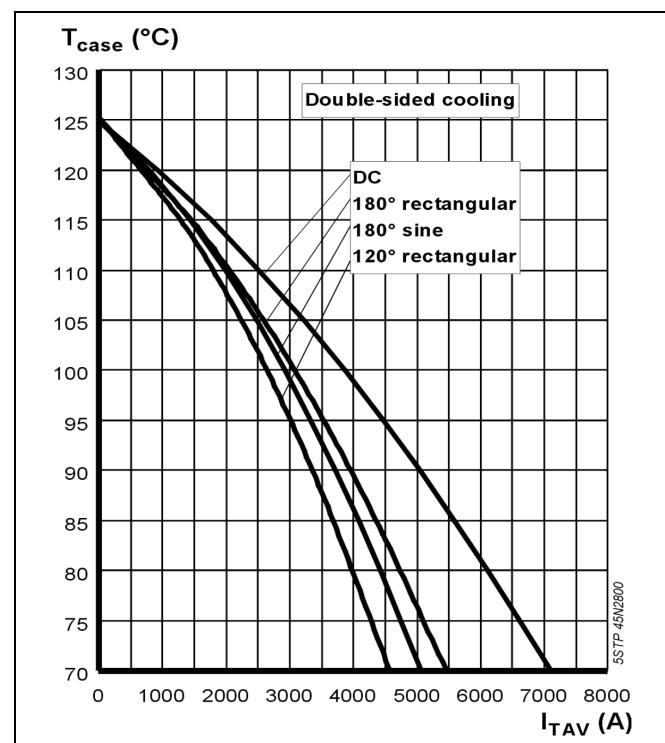
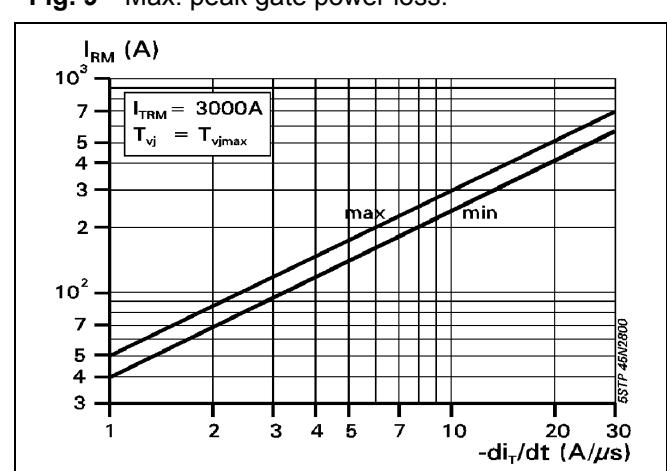
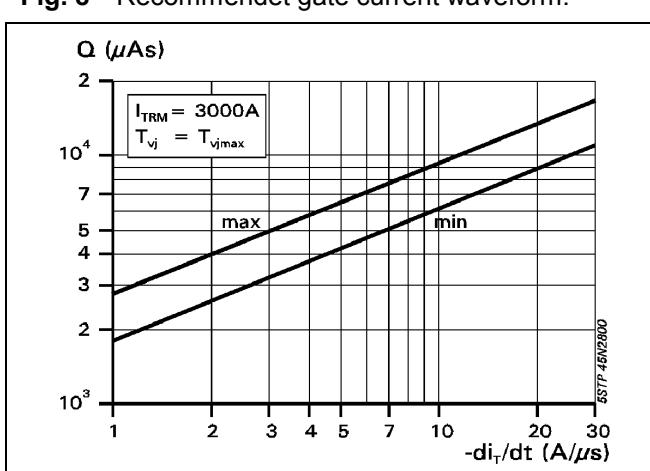
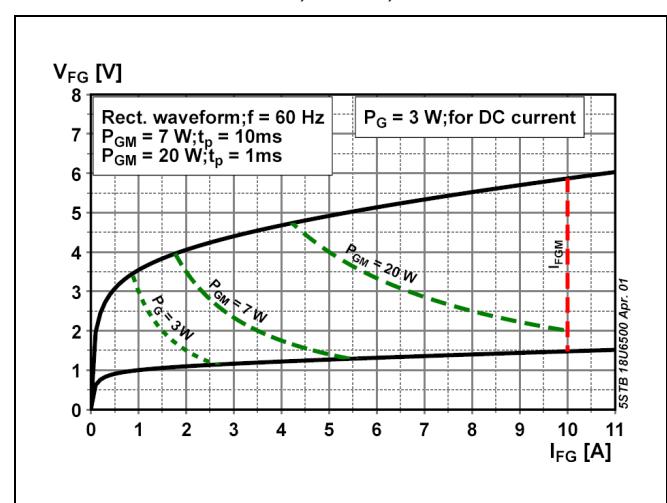
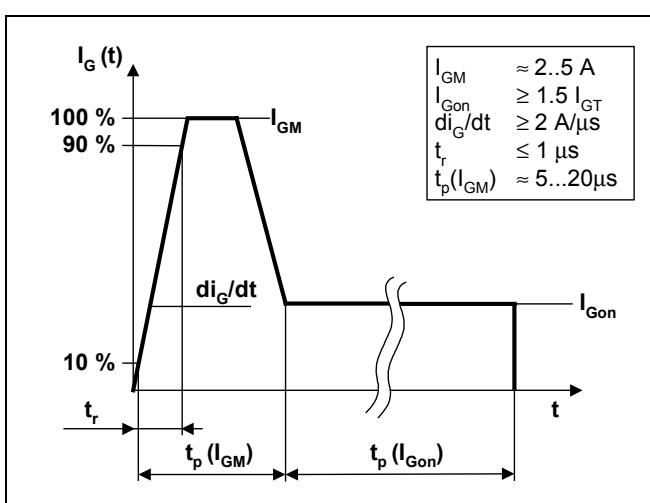
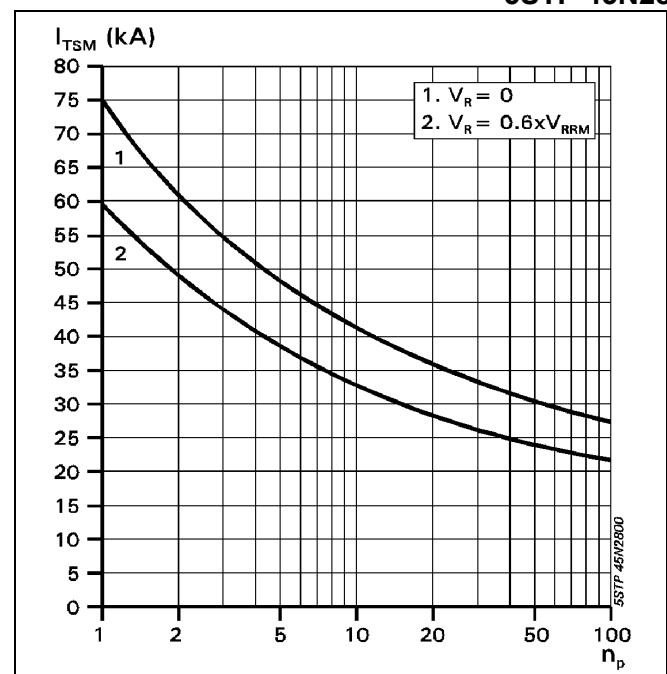
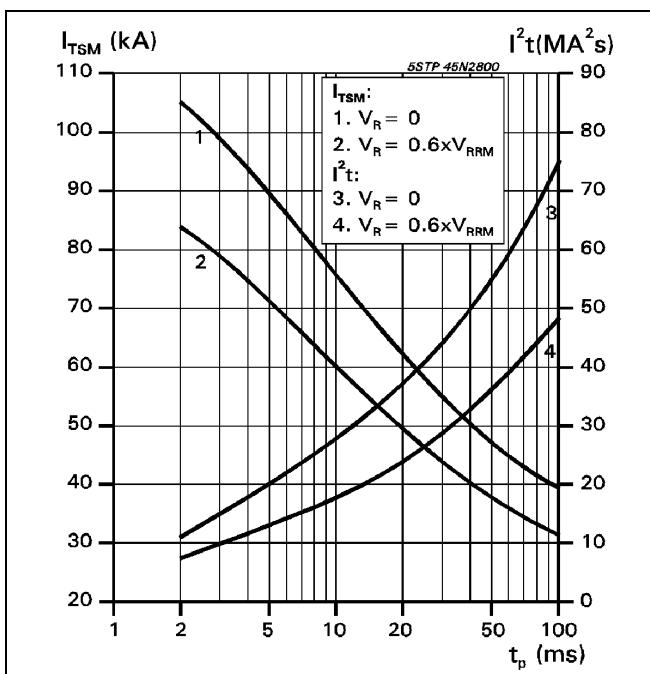


Fig. 5 Max. permissible case temperature vs. mean on-state current.



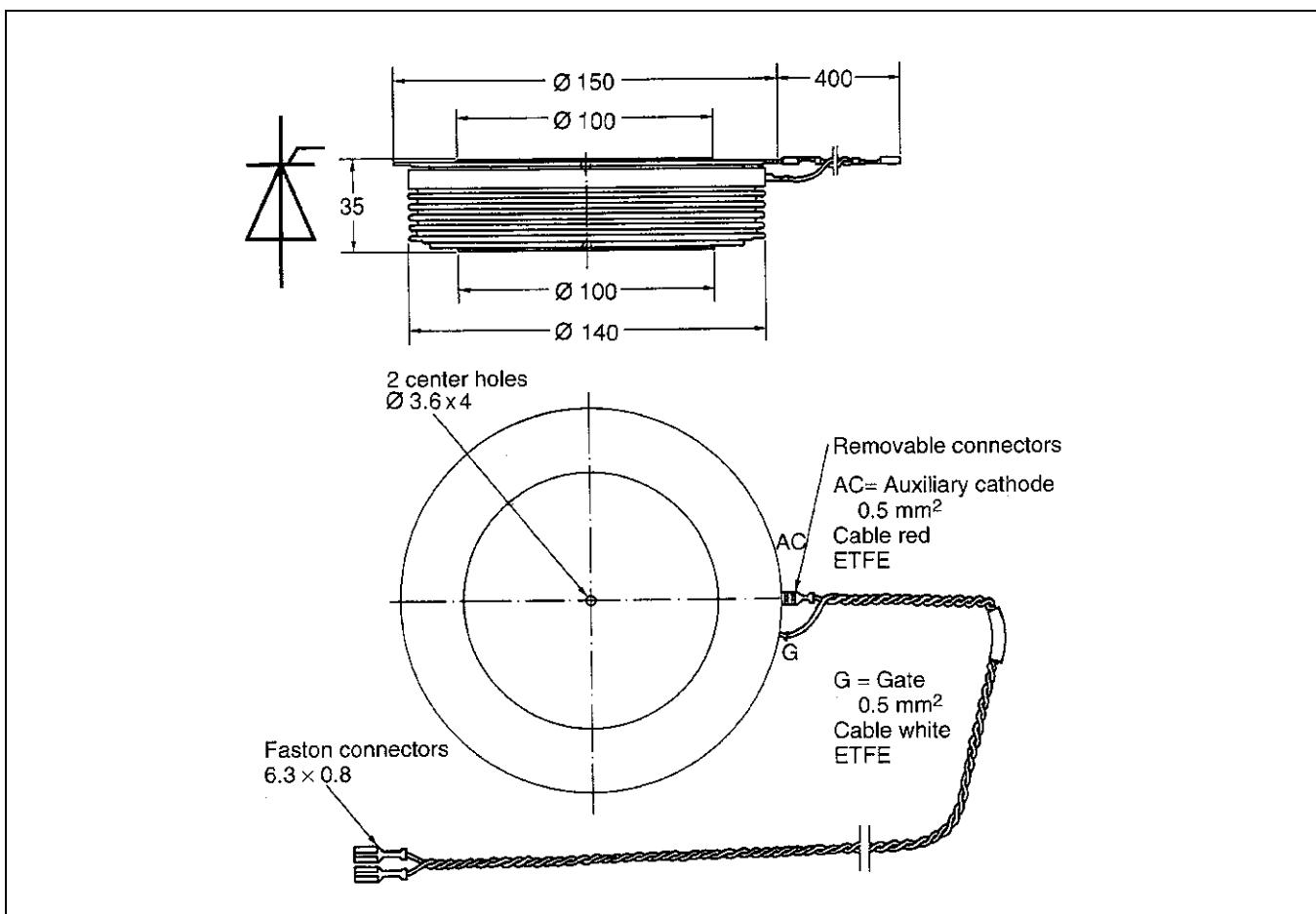


Fig. 12 Device Outline Drawing.

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